MSKSEMI 美森科













ESD

MBRA120ET3G(MS)

Product specification





FEATURES

- Highly Stable Oxidation Passivated Junction
- Guardring for Over Voltage Protection
- Optimized for Low Leakage Current
- Pb / RoHS Free

MECHANICALDATA

Case : SMA Molded plastic

• Epoxy : UL94V-O rate flame retardant

Polarity : Color band denotes cathode end

Mounting position : Any

Weight: 0.060 gram (Approximately)

Reference News

Outline	Marking
	MBRA 120
SMA	

Maximum Ratings@ TA= 25C unless otherwise specif

RATING	SYMBOL	VALUE	UNIT
Maximum Peak Repetitive Reverse Voltage	V _{RRM}	20	V
Maximum Working Peak Reversr Voltage	V _{RWM}	20	V
Maximum DC Blocking Voltage	V _{DC}	20	V
Maximum Average Forward Current at Tc = 125 °C	I _{F(AV)}	1.0	V
Maximum Non-Repetitive Peak Surge Current (Surge Applied at Rate Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	40	А
Maximum Instantaneous Forward Voltage (Note 1) $ (I_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C}) $ $ (I_F = 2.0 \text{ A}, T_J = 25^{\circ}\text{C}) $	V _F	0.530 0.595	V
Maximum Instantaneous Reverse Current (Note 1) $ (V_R = \text{rated } V_R \ , \ T_J = 25 \ ^{\circ}\text{C} \) $ $ (V_R = \text{rated } V_R \ , \ T_J = 100 \ ^{\circ}\text{C} $ $) $	I _R	10 1600	μА
Thermal Resistance Junction to Lead (Note 2)	R _{eJL}	34	°C/W
Thermal ResistanceJunction to Ambient (Note 2)	R ₀ JA	138	°C/W
Storage/Operating Junction Temperature Range	T _{STG} ,T _J	- 55 to + 150	°C

Notes

- (1) Pulse Test: Pulse Width ≤ 250 µs, Duty Cycle≤ 2 %.
- (2) Mounted on a Pad Size of 5 mm × 5 mm, PC Board FR4 (2 pads).



FIG.1 - CURRENT DERATING, JUNCTION TO CASE

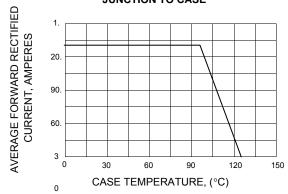


FIG.2 - TYPICAL JUNCTION CAPACITANCE

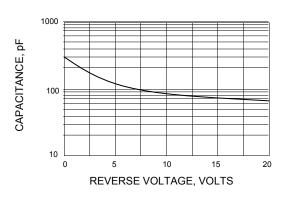


FIG.3 - MAXIMUM INSTANTANEOUS FORWARD VOLTAGE

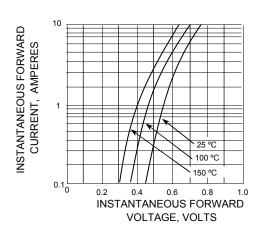


FIG. 4 - TYPICAL REVERSE CURRENT

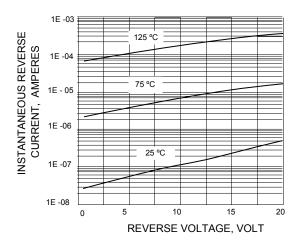
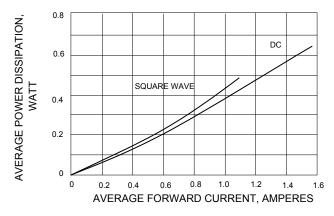
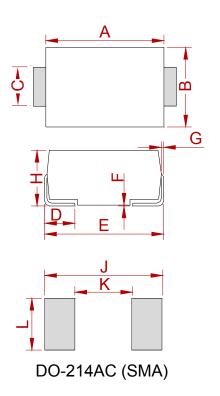


FIG. 5 – FORWARD POWER DISSIPATION



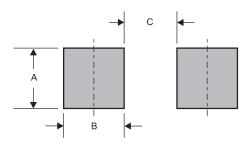


PACKAGE MECHANICAL DATA



	Dimensions			
Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
Α	4.25	4.65	0.167	0.183
В	2.50	2.90	0.098	0.114
С	1.35	1.65	0.053	0.065
D	0.76	1.52	0.030	0.060
E	4.93	5.28	0.194	0.208
F	0.051	0.203	0.002	0.008
G	0.15	0.31	0.006	0.012
Н	1.98	2.41	0.078	0.095
J	6.50		0.256	
K		2.30		0.090
L	1.70		0.067	

Suggested solder pad layout



Dimensions in inches and (millimeters)

PACKAGE	А	В	С
SMA	0.110 (2.80)	0.063 (1.60)	0.087 (2.20)

REELSPECIFICATION

P/N	PKG	QTY
MBRA120ET3G(MS)	SMA	2000



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